

AMS-FOB

500mA 8.0kV 40nS

Ultra-Fast Recovery High Voltage Silicon Rectifier Diodes

INTRODUCE:

AMS high voltage silicon rectifier diode is made of high quality glass passivated chip and high reliability epoxy resin sealing structure.

FEATURES:

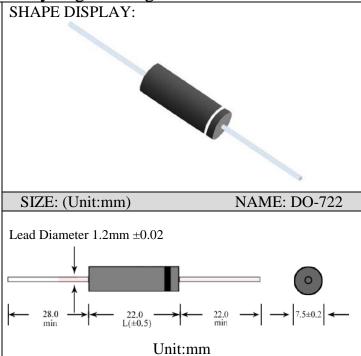
- 1. High reliability design.
- 2. High voltage, large current.
- 3. High frequency, Fast recovery.
- 4. Conform to RoHS and SGS.

APPLICATIONS:

- 1. High voltage multiplier circuit
- 2. High frequency switching power supply
- 3. General purpose high voltage rectifier.
- 4. Laser power supply medical equipment

MECHANICAL DATA:

- 1. Case: epoxy resin molding.
- 2. Terminal: welding axis.
- 3. Net weight: 2.55 grams (approx).



MAXIMUM RATINGS AND CHARACTERISTICS: (Absolute Maximum Ratings)

Items	Symbols	Condition	Data Value	Units		
Repetitive Peak Reverse Voltage	V_{RRM}	$T_A=25^{\circ}C$	8.0	kV		
Non-Repetitive Peak Reverse Voltage	V_{RSM}	$T_A=25^{\circ}C$		kV		
Average Forward Current Maximum	I_{FAVM}	$T_A=55^{\circ}C$	500	mA		
		T _{OIL} =55°C		mA		
Non-Repetitive Forward Surge Current	I_{FSM}	T _A =25°C; 50Hz Half-Sine Wave; 8.3mS	20	A		
Junction Temperature	$T_{\rm J}$		150	°C		
Allowable Operation Case Temperature	T _c		-40~+150	°C		
Storage Temperature	T_{STG}		-40~+150	°C		
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ELECTRICAL CHARACTERISTICS: TA=25°C (Unless Otherwise Specified)							
Items	Symbols	Condition	Data Value	Units			
Maximum Forward Voltage Drop	$V_{\rm FM}$	at 25°C; at I _{FAVM}	12	V			
Maximum Reverse Current	I_{R1}	at 25°C; at V _{RRM}	0.5	uA			
	I_{R2}	at 125°C; at V _{RRM}	50	uA			
Maximum Reverse Recovery Time	T_{RR}	at 25°C; $I_F=0.5A$; $I_R=I_{FAVM}$; $I_{RR}=0.25mA$	40	nS			
Junction Capacitance	Cı	at 25°C: V _R =0V: f=1MHz	7.5	рF			

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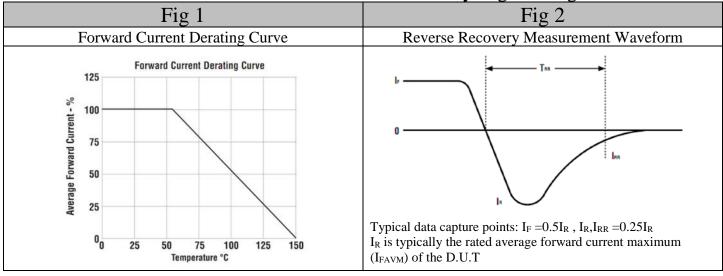


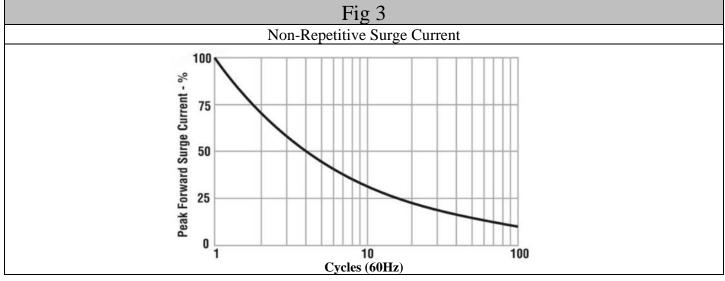


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Ultra-Fast Recovery High Voltage Silicon Rectifier





	Type	Code	Cathode Mark
Marking			lo O

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